# INTEGRATED CIRCUITS

# DATA SHEET

# 74ABT2245

Octal transceiver with direction pin with  $30\Omega$  series termination resistors (3-State)

Product specification Supersedes data of 1996 Sep 10 IC23 Data Handbook





# Octal transceiver with direction pin and $30\Omega$ series termination resistors (3-State)

# 74ABT2245

#### **FEATURES**

- Octal bidirectional bus interface
- 3-State buffers
- Output capability: +12mA/-32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 833 Method 3015 and 200 V per Machine Model
- Power-up 3-State
- Live insertion/extraction permitted
- Same as 74ABT245-1
- Outputs include series resistance of 30Ω, making external termination resistors unnecessary
- Inputs are disabled during 3-State mode

#### **DESCRIPTION**

The 74ABT2245 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed.

The 74ABT2245 device is an octal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features an Output Enable ( $\overline{OE}$ ) input for easy cascading and a Direction (DIR) input for direction control.

The 74ABT2245 is designed with  $30\Omega$  series resistance in both the High and Low states of the output. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus receivers/transmitters.

The 74ABT2245 is the same as the 74ABT245-1. The part number has been changed to reflect industry standards.

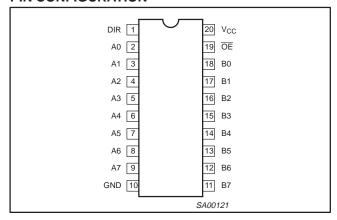
### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C; GND = 0V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	$C_L = 50pF; V_{CC} = 5V$	3.9	ns
C <sub>IN</sub>	Input capacitance DIR, OE	V <sub>I</sub> = 0V or V <sub>CC</sub>	4	pF
C <sub>I/O</sub>	I/O pin capacitance	Outputs disabled; $V_O = 0V$ or $V_{CC}$	7	pF
I <sub>CCZ</sub>	Total supply current	Outputs disabled; V <sub>CC</sub> =5.5V	50	μΑ

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER	
20-Pin Plastic DIP	-40°C to +85°C	74ABT2245 N	74ABT2245 N	SOT146-1	
20-Pin plastic SO	-40°C to +85°C	74ABT2245 D	74ABT2245 D	SOT163-1	
20-Pin Plastic SSOP Type II	-40°C to +85°C	74ABT2245 DB	74ABT2245 DB	SOT339-1	
20-Pin Plastic TSSOP Type I	-40°C to +85°C	74ABT2245 PW	7ABT2245PW DH	SOT360-1	

#### **PIN CONFIGURATION**



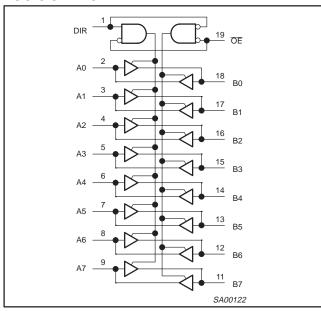
#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION				
1	DIR	Direction control input				
2, 3, 4, 5, 6, 7, 8, 9	A0 – A7	Data inputs/outputs (A side)				
18, 17, 16, 15, 14, 13, 12, 11	B0 – B7	Data inputs/outputs (B side)				
19	ŌĒ	Output enable input (active-Low)				
10	GND	Ground (0V)				
20	V <sub>CC</sub>	Positive supply voltage				

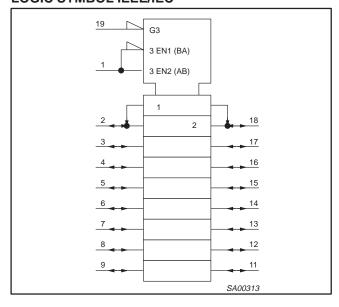
# Octal transceiver with direction pin and $30\Omega$ series termination resistors (3-State)

74ABT2245

### **LOGIC SYMBOL**



## LOGIC SYMBOL IEEE/IEC



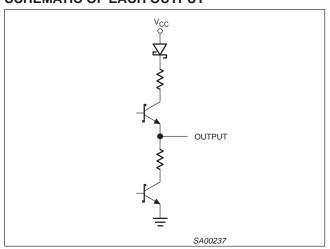
### **FUNCTION TABLE**

INPU	JTS	INPUTS/OUTPUTS				
ŌĒ	DIR	An	Bn			
L	L	An = Bn	Inputs			
L	Н	Inputs	Bn = An			
Н	Х	Z	Z			

H = High voltage level
L = Low voltage level

X = Don't care Z = High impedance "off" state

## **SCHEMATIC OF EACH OUTPUT**



# Octal transceiver with direction pin and $30\Omega$ series termination resistors (3-State)

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## ABSOLUTE MAXIMUM RATINGS1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	-18	mA
VI	DC input voltage <sup>3</sup>		-1.2 to +7.0	V
lok	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +5.5	V
I <sub>OUT</sub>	DC output current	output in Low state	128	mA
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C

#### NOTES:

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	ITS	UNIT
		Min	Max	
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V <sub>CC</sub>	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Low-level Input voltage		0.8	V
I <sub>OH</sub>	High-level output current		-32	mA
I <sub>OL</sub>	Low-level output current		12	mA
Δt/Δν	Input transition rise or fall rate	0	5	ns/V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

# Octal transceiver with direction pin and $30\Omega$ series termination resistors (3-State)

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### DC ELECTRICAL CHARACTERISTICS

						LIMITS			
SYMBOL PARAME		ETER	TEST CONDITIONS	Tai	<sub>mb</sub> = +25	°C		-40°C 85°C	UNIT
				Min	Тур	Max	Min	Max	
V <sub>IK</sub>	Input clamp volt	age	V <sub>CC</sub> = 4.5V; I <sub>IK</sub> = -18mA		-0.9	-1.2		-1.2	V
	High-level output voltage		$V_{CC} = 4.5V$ ; $I_{OH} = -3mA$ ; $V_I = V_{IL}$ or $V_{IH}$	2.5	2.9		2.5		V
V <sub>OH</sub>			$V_{CC} = 5.0V$ ; $I_{OH} = -3mA$ ; $V_I = V_{IL}$ or $V_{IH}$	3.0	3.4		3.0		V
			$V_{CC} = 4.5V$ ; $I_{OH} = -32mA$ ; $V_I = V_{IL}$ or $V_{IH}$	2.0	2.4		2.0		V
.,			$V_{CC} = 4.5V$ ; $I_{OL} = 5mA$ ; $V_I = V_{IL}$ or $V_{IH}$		0.32	0.55		0.55	V
V <sub>OL</sub>	Low-level output voltage		$V_{CC} = 4.5V$ ; $I_{OL} = 12mA$ ; $V_I = V_{IL}$ or $V_{IH}$		0.5	0.8		0.8	V
,	Input leakage Control pins		V <sub>CC</sub> = 5.5V; V <sub>I</sub> = GND or 5.5V		±0.01	±1.0		±1.0	μΑ
l <sub>l</sub>	current Data pins		$V_{CC} = 5.5V; V_I = GND \text{ or } 5.5V$		±5	±100		±100	μΑ
I <sub>OFF</sub>	Power-off leakage current		$V_{CC} = 0.0V; V_{I} \text{ or } V_{O} \le 4.5V$		±5.0	±100		±100	μА
I <sub>PU</sub> /I <sub>PD</sub>	Power-up/down output current <sup>3</sup>	3-State	$V_{\underline{CC}}$ = 2.1V; $V_{\underline{O}}$ = 0.5V; $V_{\underline{I}}$ = GND or $V_{\underline{CC}}$ ; $V_{\underline{OE}}$ = Don't care		±5.0	±50		±50	μА
I <sub>IH</sub> + I <sub>OZH</sub>	3-State output H	High current	$V_{CC} = 5.5V; V_{O} = 2.7V; V_{I} = V_{IL} \text{ or } V_{IH}$		5.0	50		50	μА
I <sub>IL</sub> + I <sub>OZL</sub>	3-State output L	ow current	$V_{CC} = 5.5V; V_O = 0.5V; V_I = V_{IL} \text{ or } V_{IH}$		-5.0	-50		-50	μА
I <sub>CEX</sub>	Output high lea	kage current	$V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GND \text{ or } V_{CC}$		5.0	50		50	μА
Io	Output current <sup>1</sup>		$V_{CC} = 5.5V; V_{O} = 2.5V$	-40	-100	-180	-40	-180	mA
Іссн			$V_{CC}$ = 5.5V; Outputs High, $V_{I}$ = GND or $V_{CC}$		50	250		250	μА
I <sub>CCL</sub>	Quiescent supp	ly current	$V_{CC} = 5.5V$ ; Outputs Low, $V_I = GND$ or $V_{CC}$		24	30		30	mA
I <sub>CCZ</sub>	- Quioscont supply current		$V_{CC}$ = 5.5V; Outputs 3-State; $V_I$ = GND or $V_{CC}$		50	250		250	μА
			Outputs enabled, one input at 3.4V, other inputs at $V_{CC}$ or GND; $V_{CC}$ = 5.5V		0.5	1.5		1.5	mA
Δl <sub>CC</sub>	Additional supp input pin <sup>2</sup>	ly current per	Outputs 3-State, one data input at 3.4V, other inputs at $V_{CC}$ or GND; $V_{CC} = 5.5V$		50	250		250	μА
			Outputs 3-State, one enable input at 3.4V, other inputs at $V_{CC}$ or GND; $V_{CC} = 5.5V$		0.5	1.5		1.5	mA

#### NOTES:

- 1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input at 3.4V.
   This parameter is valid for any V<sub>CC</sub> between 0V and 2.1V with a transition time of up to 10msec. From V<sub>CC</sub> = 2.1V to V<sub>CC</sub> = 5V ± 10%, a transition time of up to 100μsec is permitted.

# Octal transceiver with direction pin and $30\Omega$ series termination resistors (3-State)

74ABT2245

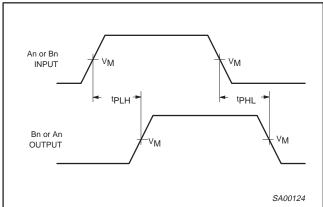
#### **AC CHARACTERISTICS**

GND = 0V;  $t_R$  =  $t_F$  = 2.5ns;  $C_L$  = 50pF,  $R_L$  = 500 $\Omega$ 

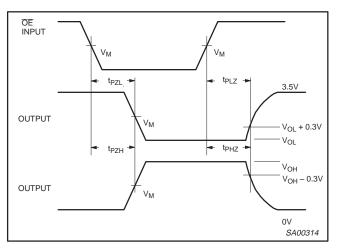
			LIMITS					
SYMBOL	PARAMETER	WAVEFORM	T <sub>e</sub>	<sub>amb</sub> = +25° 'CC = +5.0°	C V	T <sub>amb</sub> = -40° V <sub>CC</sub> = +5.	UNIT	
			Min	Тур	Max	Min	Max	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	1	1.0 1.0	2.8 3.9	4.2 5.0	1.0 1.0	4.7 5.4	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output enable time to High and Low level	2	1.3 3.0	3.5 5.5	4.6 7.0	1.3 3.0	5.5 7.8	ns
t <sub>PHZ</sub>	Output disable time from High and Low Level	2	1.5 1.0	4.0 3.4	5.4 4.6	1.5 1.0	6.3 5.0	ns

### **AC WAVEFORMS**

 $V_M = 1.5V$ ,  $V_{IN} = GND$  to 3.0V

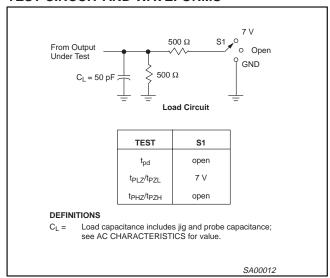


Waveform 1. Waveforms Showing the Input to Output Propagation Delays



Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

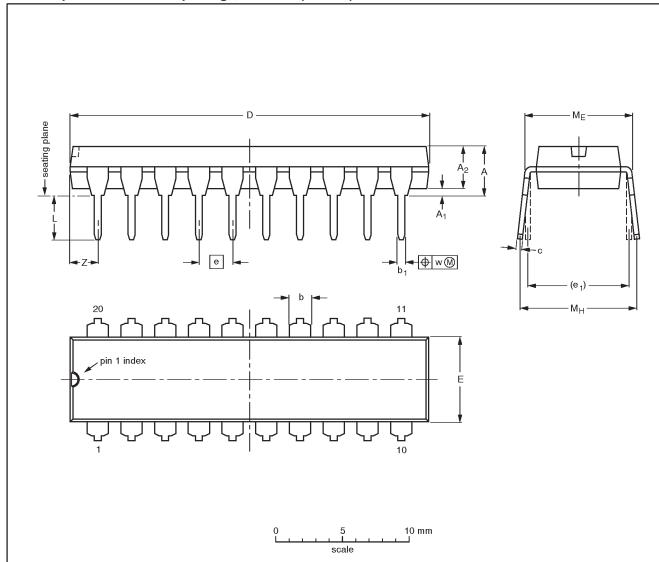
#### **TEST CIRCUIT AND WAVEFORMS**



74ABT2245

## DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

#### Note

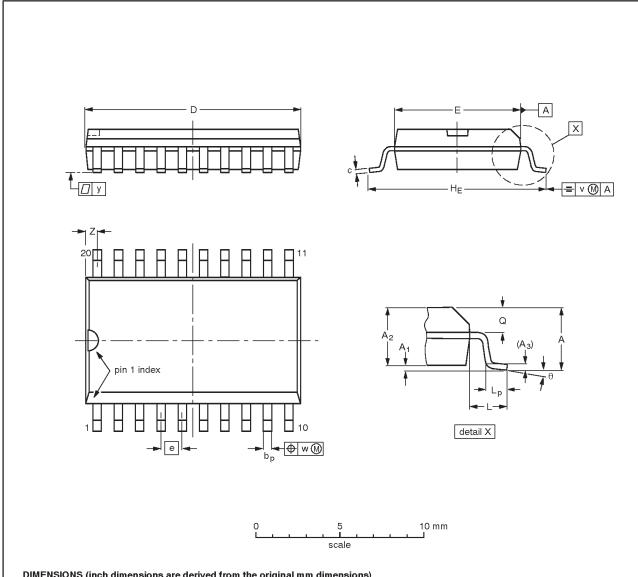
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	RSION IEC JEDEC EIAJ		PROJECTION	1330E DATE	
SOT146-1			SC603		<del>-92-11-17-</del> 95-05-24

74ABT2245

## SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	٧	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	o°

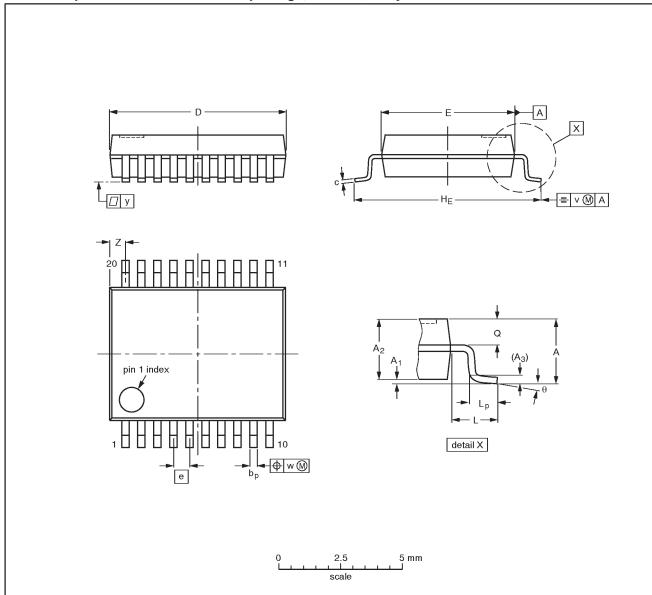
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
SOT163-1	075E04	MS-013AC			<del>-92-11-17</del> 95-01-24

74ABT2245

## SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	A <sub>3</sub>	bр	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

#### Note

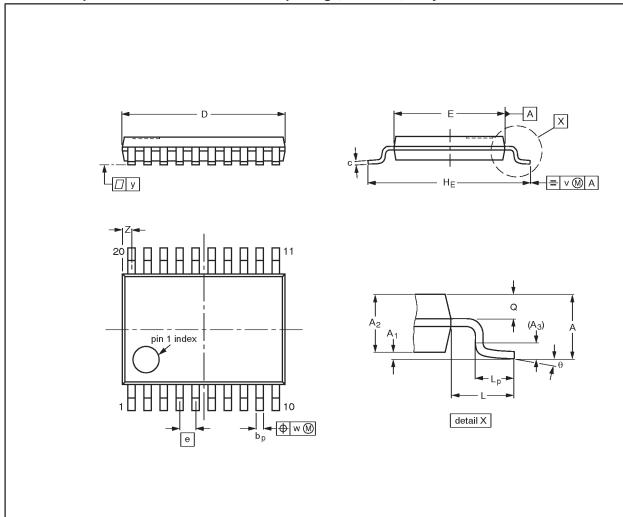
1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

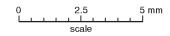
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT339-1		MO-150AE			<del>93-09-08</del> 95-02-04

74ABT2245

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1





#### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	рb	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUEDATE
SOT360-1		MO-153AC			<del>-93-06-16-</del> 95-02-04

Octal transceiver with direction pin and  $30\Omega$  series termination resistors (3-State)

74ABT2245

**NOTES** 

# Octal transceiver with direction pin and $30\Omega$ series termination resistors (3-State)

74ABT2245

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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